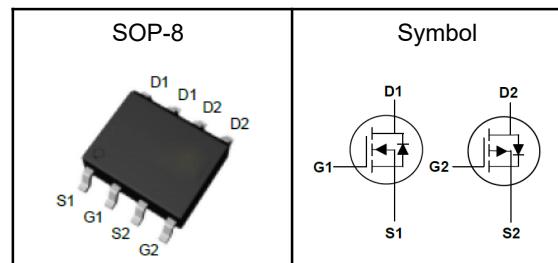


## 60V N+P-Channel MOSFET

### Features

- High Speed Power Switching
- Reliable and Rugged
- ROHS Compliant
- 100% Avalanche Tested

### Pin Description



### Applications

- Power Management in Desktop Computer
- DC/DC Converters

	N-ch	P-ch	
$V_{DSS}$	60	-60	V
$R_{DS(ON)-Typ}$	33	75	mΩ
$I_D$	5.1	-3.7	A

### Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ , Unless Otherwise Noted)

Symbol	Parameter	N-Ch	P-Ch	Unit
$V_{DSS}$	Drain-Source Voltage	60	-60	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	$\pm 20$	V
$T_J$	Maximum Junction Temperature	$-55 \text{ to } 150$		°C
$T_{STG}$	Storage Temperature Range	$-55 \text{ to } 150$		°C
$I_{DM}^{①}$	Pulse Drain Current Tested	20	-14	A
$I_D$	Continuous Drain Current	5.1	-3.7	A
$P_D$	Maximum Power Dissipation	2	2	W
$E_{AS}$	Avalanche Energy, Single pulse	12	16	mJ

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{θJA}$	Thermal Resistance-Junction to Ambient	62.5	°C/W

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C.

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

## 60V N+P-Channel MOSFET

### N-ch Electrical Characteristics ( $T_J=25^\circ\text{C}$ , Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>Static Electrical Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}$ , $\text{I}_D=250\mu\text{A}$	60	---	---	V
$\text{I}_{\text{DSS}}$	Zero Gate Voltage Drain Current	$\text{V}_{\text{DS}}=48\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$	---	---	1	$\mu\text{A}$
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}$ , $\text{I}_D=250\mu\text{A}$	1	2	3	V
$\text{I}_{\text{GSS}}$	Gate Leakage Current	$\text{V}_{\text{GS}}=\pm 20\text{V}$ , $\text{V}_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA
$\text{R}_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=5\text{A}$	---	33	40	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=4.5\text{V}$ , $\text{I}_D=4\text{A}$	---	37	48	$\text{m}\Omega$
<b>Dynamic Characteristics<sup>⑤</sup></b>						
$\text{R}_g$	Gate Resistance	$\text{V}_{\text{DS}}=0\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	3	---	$\Omega$
$\text{C}_{\text{iss}}$	Input Capacitance	$\text{V}_{\text{DS}}=30\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$ , Freq.=1MHz	---	670	---	pF
$\text{C}_{\text{oss}}$	Output Capacitance		---	70	---	
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance		---	35	---	
$\text{T}_{\text{d(on)}}$	Turn-on Delay Time	$\text{V}_{\text{DD}}=30\text{V}$ , $\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=1\text{A}$ , $\text{R}_G=6\Omega$	---	8	---	nS
$\text{T}_r$	Turn-on Rise Time		---	6	---	
$\text{T}_{\text{d(off)}}$	Turn-off Delay Time		---	23	---	
$\text{T}_f$	Turn-off Fall Time		---	6	---	
$\text{Q}_g$	Total Gate Charge	$\text{V}_{\text{DS}}=30\text{V}$ , $\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=5\text{A}$	---	14	---	nC
$\text{Q}_{\text{gs}}$	Gate-Source Charge		---	2.6	---	
$\text{Q}_{\text{gd}}$	Gate-Drain Charge		---	2.2	---	
<b>Source-Drain Characteristics</b>						
$\text{V}_{\text{SD}}$	Diode Forward Voltage	$\text{I}_s=1\text{A}$ , $\text{V}_{\text{GS}}=0\text{V}$	---	---	1.3	V
$\text{t}_{\text{rr}}$	Reverse Recovery Time	$\text{I}_F=5\text{A}$ , $d\text{I}_F/dt=100\text{A}/\mu\text{s}$	---	20	---	nS
$\text{Q}_{\text{rr}}$	Reverse Recovery Charge		---	20	---	nC

Note ④: Pulse test (pulse width $\leq 300\mu\text{s}$ , duty cycle $\leq 2\%$ ).

Note ⑤ : Guaranteed by design, not subject to production testing.

## 60V N+P-Channel MOSFET

### P-ch Electrical Characteristics ( $T_J=25^\circ\text{C}$ , Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>Static Electrical Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=-250\mu\text{A}$	-60	---	---	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-48\text{V}$ , $V_{\text{GS}}=0\text{V}$	---	---	-1	$\mu\text{A}$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=-250\mu\text{A}$	-1.2	---	-2.5	V
$I_{\text{GSS}}$	Gate Leakage Current	$V_{\text{GS}}=\pm20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm100$	$\text{nA}$
$R_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=-10\text{V}$ , $I_{\text{D}}=-3.7\text{A}$	---	75	95	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$ , $I_{\text{D}}=-2\text{A}$	---	95	130	$\text{m}\Omega$
<b>Dynamic Characteristics<sup>⑤</sup></b>						
$R_g$	Gate Resistance	$V_{\text{DS}}=0\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	10	---	$\Omega$
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-30\text{V}$ , $V_{\text{GS}}=0\text{V}$ , Freq.=1MHz	---	500	---	$\text{pF}$
$C_{\text{oss}}$	Output Capacitance		---	66	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	32	---	
$T_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=-30\text{V}$ , $V_{\text{GS}}=-10\text{V}$ , $I_{\text{D}}=-1\text{A}$ , $R_G=6\Omega$	---	7.5	---	$\text{nS}$
$T_r$	Turn-on Rise Time		---	4	---	
$T_{\text{d(off)}}$	Turn-off Delay Time		---	38	---	
$T_f$	Turn-off Fall Time		---	28	---	
$Q_g$	Total Gate Charge	$V_{\text{DS}}=-30\text{V}$ , $V_{\text{GS}}=-10\text{V}$ , $I_{\text{D}}=-3.7\text{A}$	---	12	---	$\text{nC}$
$Q_{\text{gs}}$	Gate-Source Charge		---	1.3	---	
$Q_{\text{gd}}$	Gate-Drain Charge		---	1.5	---	
<b>Source-Drain Characteristics</b>						
$V_{\text{SD}}$	Diode Forward Voltage	$I_{\text{S}}=-1\text{A}$ , $V_{\text{GS}}=0\text{V}$	---	---	-1.1	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_{\text{F}}=-3.7\text{A}$ , $dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	---	20	---	$\text{nS}$
$Q_{\text{rr}}$	Reverse Recovery Charge		---	15	---	$\text{nC}$

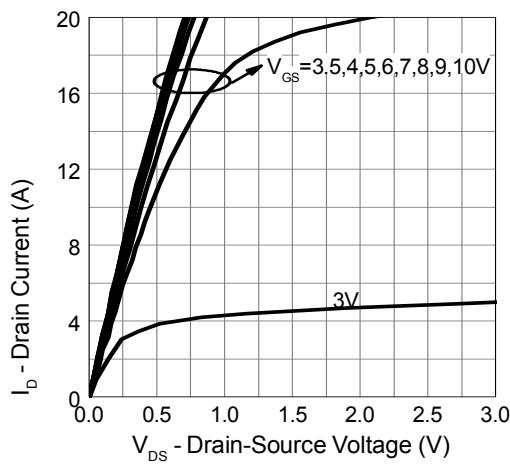
Note ④: Pulse test (pulse width $\leq300\mu\text{s}$ , duty cycle $\leq2\%$ ).

Note ⑤ : Guaranteed by design, not subject to production testing.

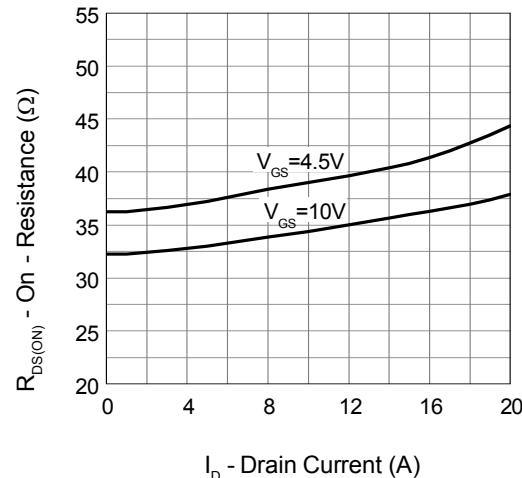
## 60V N+P-Channel MOSFET

### N-ch Typical Characteristics

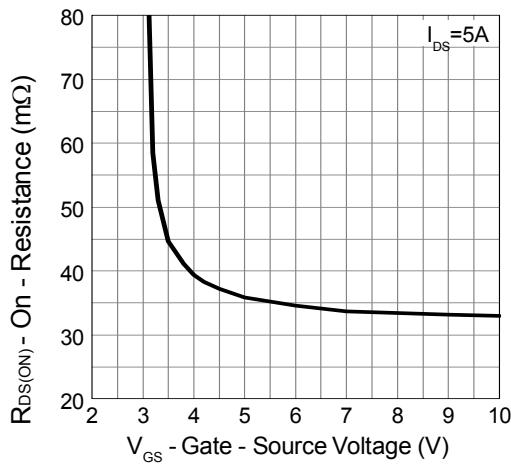
**Output Characteristics**



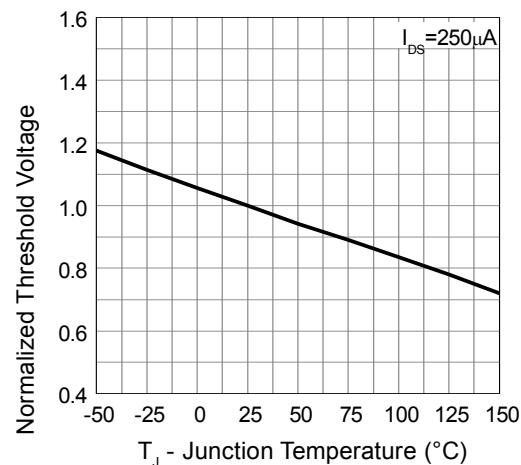
**Drain-Source On Resistance**



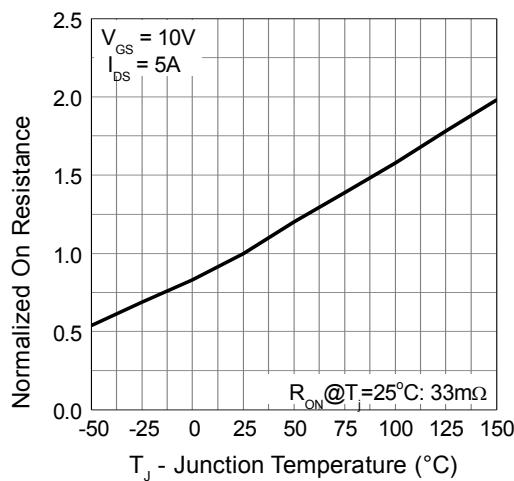
**Transfer Characteristics**



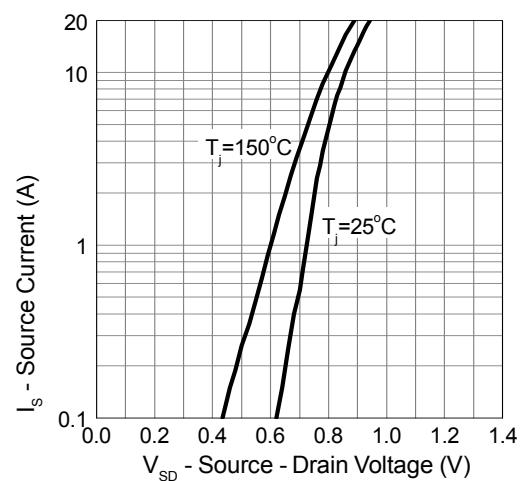
**Gate Threshold Voltage**



**Drain-Source On Resistance**

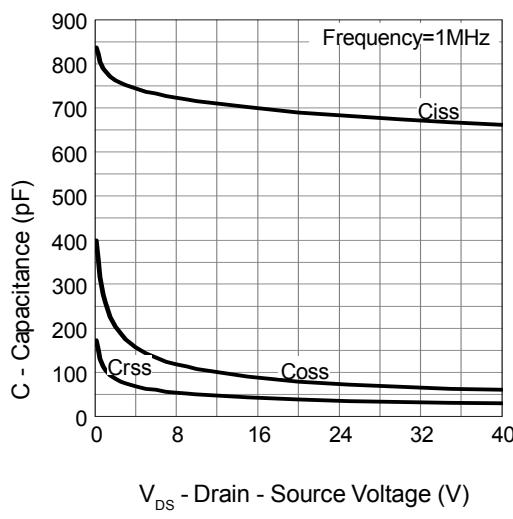


**Source-Drain Diode Forward**

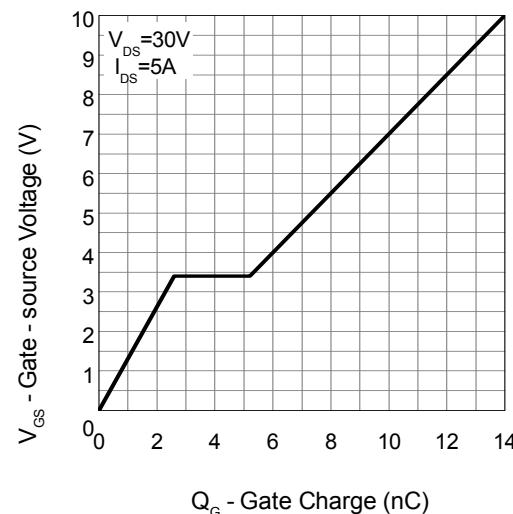


## 60V N+P-Channel MOSFET

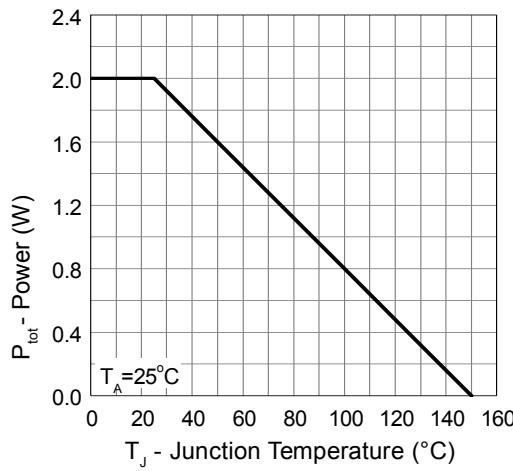
### Capacitance



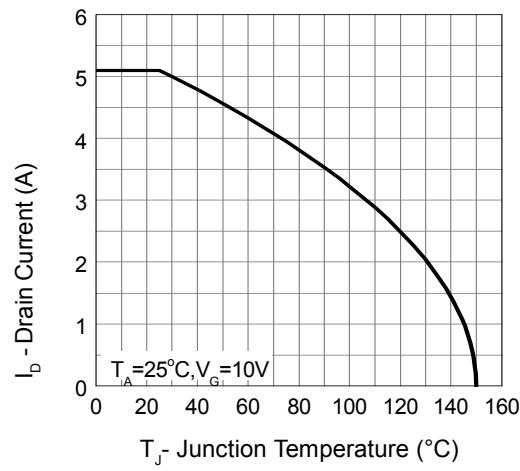
### Gate Charge



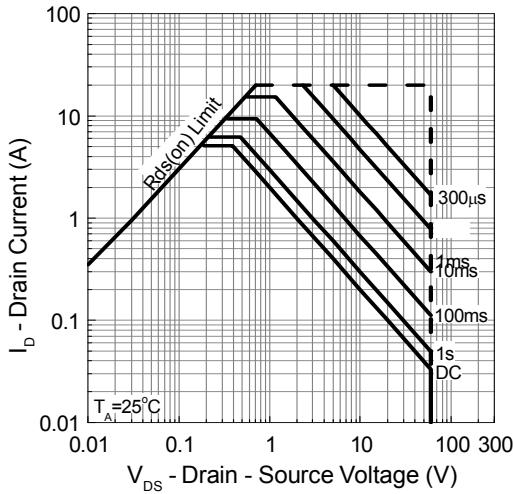
### Power Dissipation



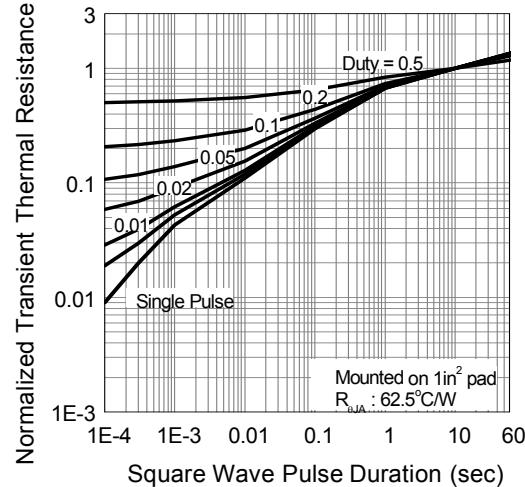
### Drain Current



### Safe Operation Area



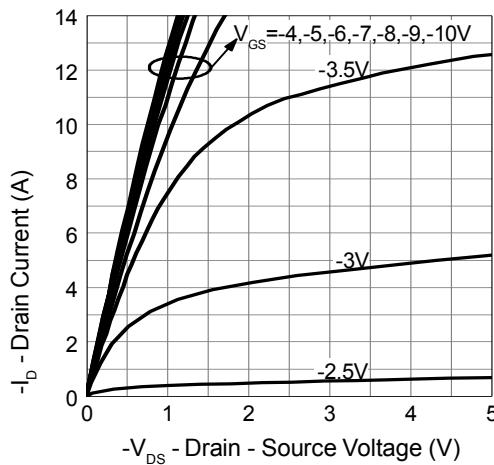
### Thermal Transient Impedance



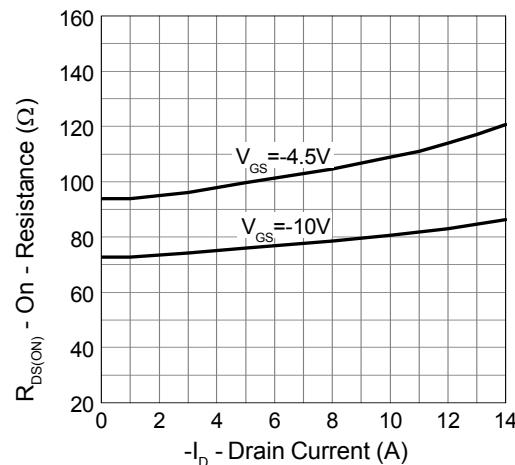
## 60V N+P-Channel MOSFET

### P-ch Typical Characteristics

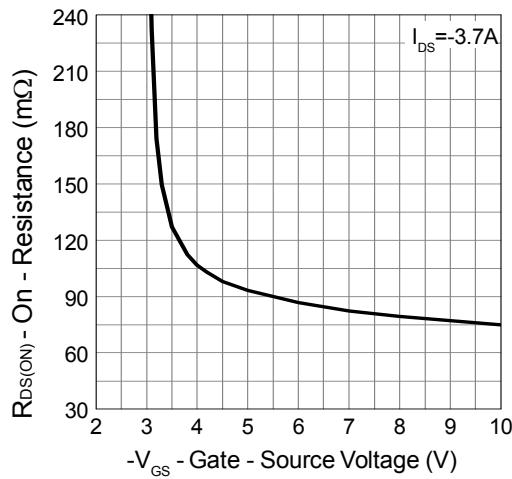
**Output Characteristics**



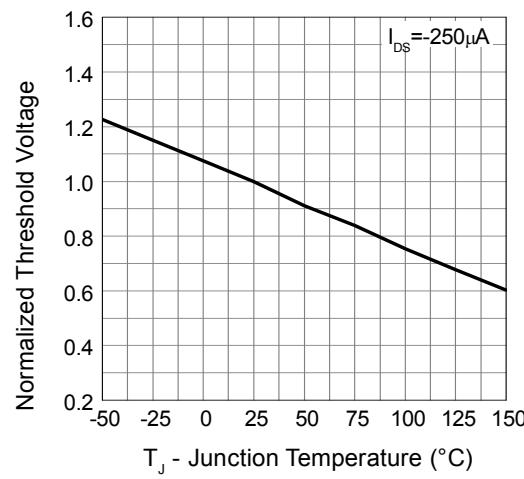
**Drain-Source On Resistance**



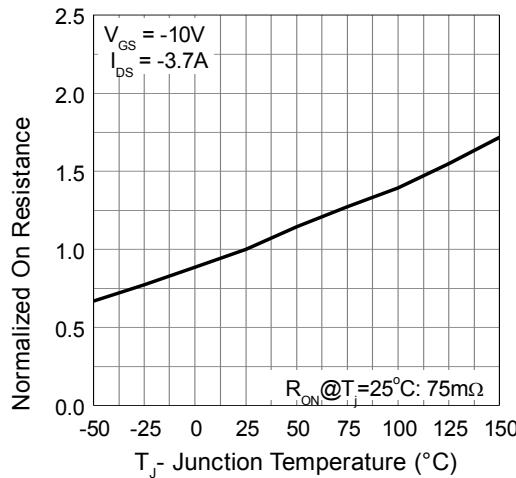
**Transfer Characteristics**



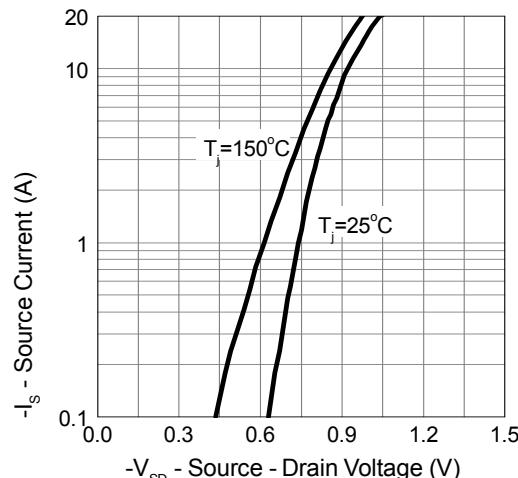
**Gate Threshold Voltage**



**Drain-Source On Resistance**

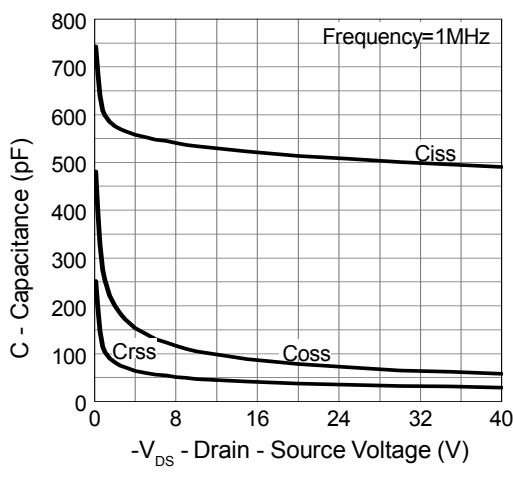


**Source-Drain Diode Forward**

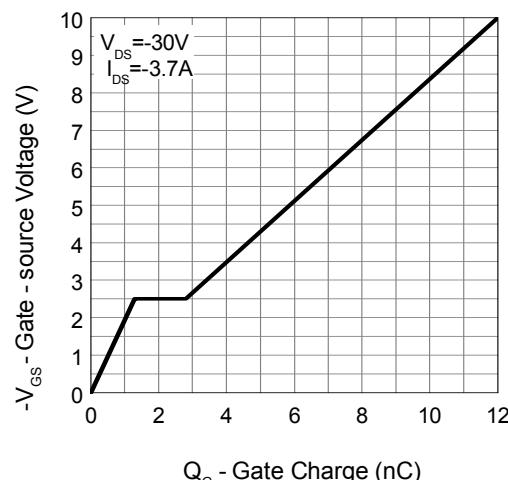


## 60V N+P-Channel MOSFET

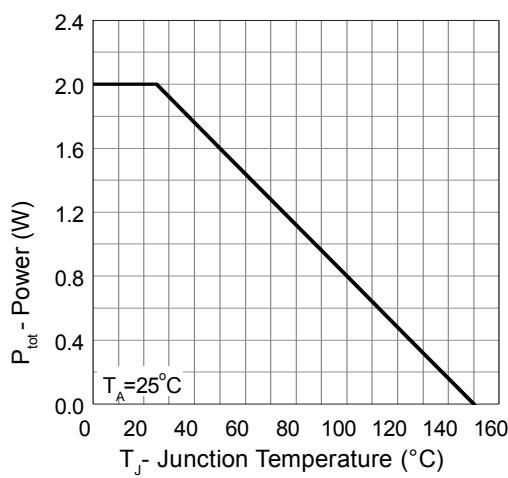
### Capacitance



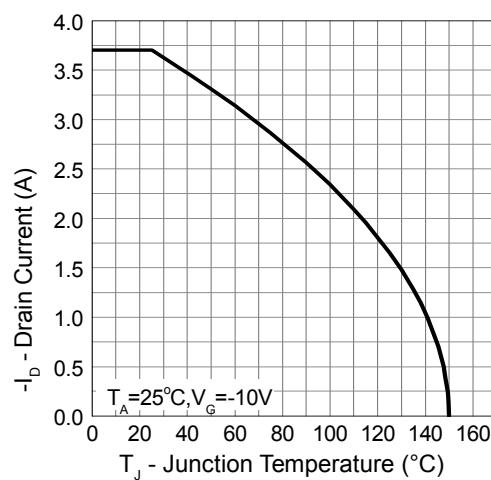
### Gate Charge



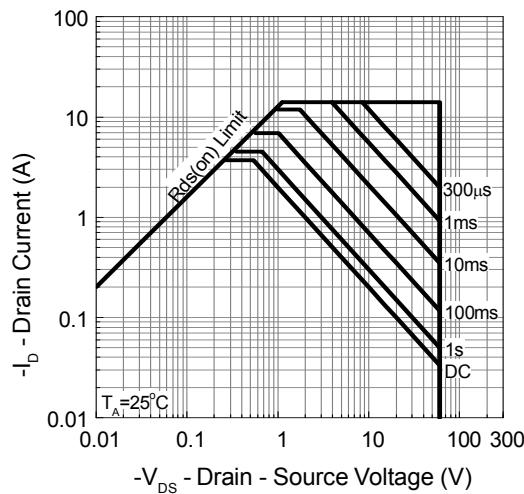
### Power Dissipation



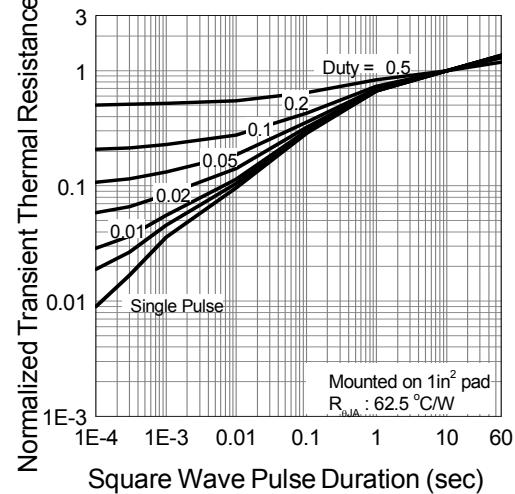
### Drain Current



### Safe Operation Area

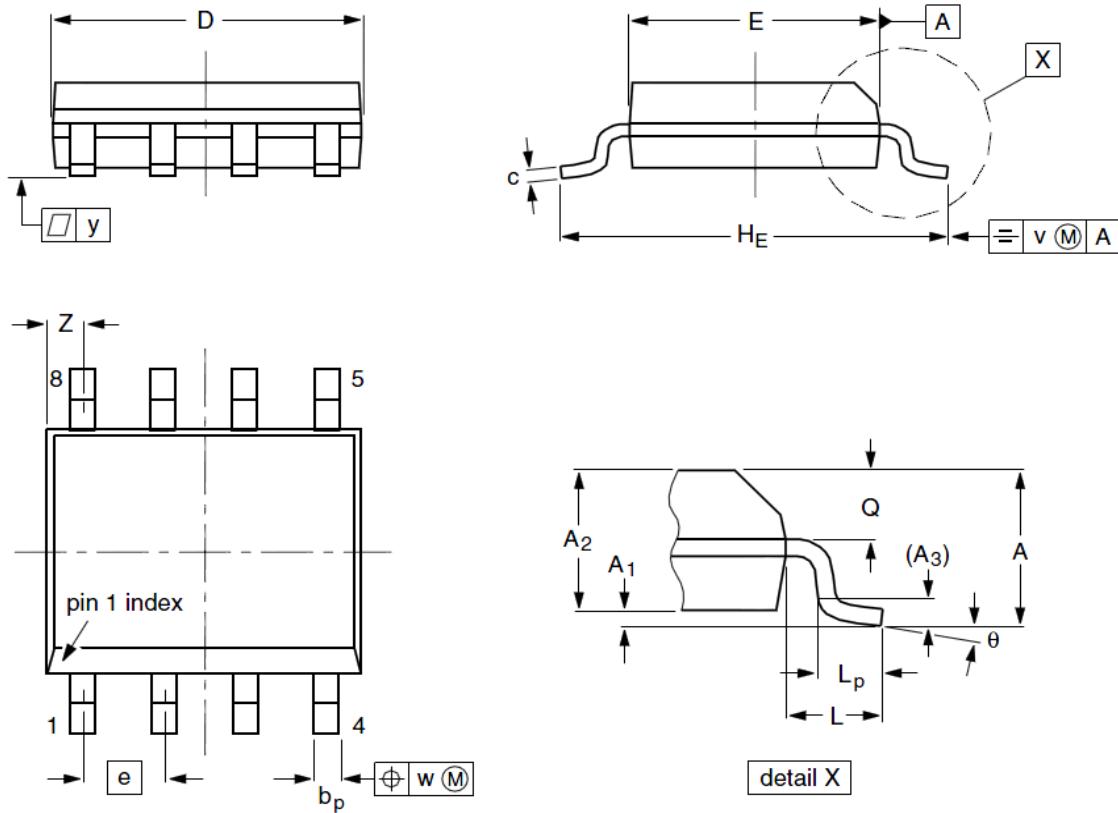


### Thermal Transient Impedance



## 60V N+P-Channel MOSFET

### SOP-8 Package Outline Dimensions



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
<b>A</b>	1.35	1.55	1.75	<b>A<sub>1</sub></b>	0.10	0.18	0.25
<b>A<sub>2</sub></b>	1.25	1.45	1.65	<b>A<sub>3</sub></b>	--	0.25	--
<b>b<sub>p</sub></b>	0.36	0.42	0.51	<b>c</b>	0.19	0.22	0.25
<b>D</b>	4.70	4.92	5.10	<b>E</b>	3.80	3.90	4.00
<b>e</b>	--	1.27	--	<b>H<sub>E</sub></b>	5.80	6.00	6.20
<b>L</b>	--	1.05	--	<b>L<sub>P</sub></b>	0.40	0.68	1.00
<b>Q</b>	0.60	0.65	0.73	<b>v</b>	--	0.25	--
<b>w</b>	--	0.25	--	<b>y</b>	--	0.10	--
<b>Z</b>	0.30	0.50	0.70	<b>θ</b>	0°		8°